PTO/SE/08-In (08-03)
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Substitute for form 1449A/B/PTO				Complete If Known		
				Application Number	10/810,719-Conf. #8916	
	INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Uso as many shoets as necessary)			Filing Date	March 29, 2004	
S				First Named Inventor	Panayotts C. Andricacos	
				Art Unit	1753	
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Sheat	1	of	1	Attorney Docket Number	20140-00255-US2	

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Examiner Initialis*	Cita No.	Document Number Number-Kind Gode ² (Finner)	Publication Date MM-DD-YYYY		Name of Patentee or pplicant of Citad Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
$\perp M$	AA"	US-5,484,518	01/1996	GOLDBE	RG	
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Fremine	CH-	Foreign Petent Docum	nent i	Publication	No 10-1	Panes, Columns Lines.

<u> </u>	,	FORE	GN PATENT	DOCUMENTS		
Examinor In Male 7		Foreign Patient Document Country Code ³ -Humber ⁴ -Kind Code ⁸ (I Innern)	L	Approxim or clied Coccilians	Pages, Columns, Lines, Whore Rolevent Passages or Rolevent Figures Appear	7
WA	/ BA**	EP-0952242	11-16-1998	LANDAU, et al.		\vdash

EVAMINER: Initial if returnes considered, whether or not obtain is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered, lexible copy of this form with next communication to applicant. "CITE NO.: Those potenties or publication(s) which are marked with an double activities (") next to the CEs No. are not supplied because they were previously cited by or submitted to the Office in a prior application retied upon in this spollication for an earlier filling data under 35 U.S.C. 120. "Applicants unique cited and designation number (options)." See Kinds Codes of USPTO Patent Documents at https://www.uspto.org/cited/pitch/signature/ (INFO Supplements at https://www.uspto.org/cited/pitch/signature/ (INFO Supplements at https://www.uspto.org/cited/pitch/signature/ (INFO Supplements patent obscurred). "For Japanese patent occurred, the indication of the year of the reign of the Emperer must precade the serial number of the patent document." Kind of document by the appropriate symbols as indicated on the document under MPO Standard ST.16 if possible. "Applicant is to place a checkt mark here if English language Translation is allocated."

	:	NON PATENT LITERATURE DOCUMENTS		
xaminer iliais	No.1	trictude name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (magazine, journed, serial, symposium, catalog, etc.), date, page(a), votume-leave number(s), publisher, and/or opunity where published.		
AG	GA**	A Novel Electrolyte Composition for Copper Plating in Wafer Metallization; Electrochemical Processing in ULSI Fabrication and Semiconductor/Metal Deposition II: Proceedings of the International Symposium; P.C.: Uziel LANDAU, et al., The Electrochemical Society, Inc. Proceedings Volume 99-9.		
	CB**	A Model of Superfilling in Damascene Electropiating; H. DELIGIANNI, et al.; The 195 th Meeting of Electrochemical Society, Inc. Meeting Abstracts, Volume 99-1 (May 2-8, 1999)	r	
	cc	Electrochemical Society, Inc. Meeting Abstracts, Volume 99-1 (May 2-8, 1999)	-	
	CD**	A Model of Superfilling in Damascene Electroplating, H. DELIGIANNI, et al.; Electrochemical Processing In ULSI Fabrication and Semiconductor/Metal Deposition II: Proceedings of the International Symposium; P.C.; Uziel LANDAU, et al., The Electrochemical Society, Inc., Proceedings Volume 99-9.		
	CE**	Uziel LANDAU, A Novel Electrolyte Composition for Copper Plating in Wafer Metallization, Abstract No. 283.	_	
1		Model of Wafer Thickness Uniformity in an Electrocopiating Tool, Electrochemical Processing in ULSI Fabrication and Semicondutor/Metal Deposition II: Proceedings of the International Symposium; P.C.H. DELIGIANNI, et al., The Electrochemical Society, Inc., Proceedings Volume 99-9.		
R	cc	Computational Aspects of the Terminal Effect on Wafer-Scale Uniformity, H. DELIGIANNI et al.; The 195 Meeting of Electrochemical Society, Inc. Meeting Abstracts, Volume 99-1 (May 2-6, 1999).	_	

"EXAMINER: Initial if systemace considered, whether or the creation is in conformance with MPEP 608. Once the discount rest in conformance and not considered. Include play of sits form with next/complicitation to expectage. "PCITE NO.: Those patent(s) or publication(s) which are marked with an double expectation for an experience of the policy of the conformance and not considered to the Critics on a prior experience of the conformance and not considered to the Critics on a prior experience of the conformance and not conformance and not considered to the Critics on a prior experience of the conformance and not conforma

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